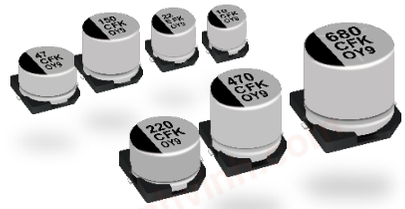
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Panasonic
INDUSTRY

Aluminum Electrolytic Capacitors

Surface Mount Type

FK series



Features

- Endurance：105 ℃ 2000 h to 5000 h
- Low impedance（40 % to 60 % less than FC series）
- Miniaturized (30 % to 50 % less than FC series)
- Vibration-proof product (30G guaranteed) is available upon request（ø6.3 ≦）
- AEC-Q200 compliant
- RoHS compliant

Specifications

Category temp. range	–55 ℃ to +105 ℃										
Rated voltage range	6.3 V to 100 V										
Capacitance range	3.3 μF to 6800 μF										
Capacitance tolerance	±20 % (120 Hz / +20 ℃)										
Leakage current	I ≦ 0.01 CV or 3 (μA) After 2 minutes (Whichever is greater)										
Dissipation factor (tan δ)	Please see the attached characteristics list										
Characteristics at low temperature	Rated voltage (V)	6.3	10	16	25	35	50	63	80	100	(Impedance ratio at 120 Hz)
	Z (–25 ℃) / Z (+20 ℃)	2	2	2	2	2	2	2	2	2	
	Z (–40 ℃) / Z (+20 ℃)	3	3	3	3	3	3	3	3	3	
	Z (–55 ℃) / Z (+20 ℃)	4	4	4	3	3	3	3	3	3	
Endurance	After applying rated working voltage for 2000 hours at +105 ℃ ± 2 ℃ and then being stabilized at +20 ℃, capacitors shall meet the following limits. （≧ ø12.5 and suffix “G” in ø8×10.2, ø10×10.2 are 5000 hours）										
	Capacitance change	Within ±30 % of the initial value (Suffix “G” is 35 %)									
	Dissipation factor（tan δ）	≦ 200 % of the initial limit (Suffix “G” is 300 %)									
	Leakage current	Within the initial limit									
Shelf life	After storage for 1000 hours at +105 ℃ ± 2 ℃ with no voltage applied and then being stabilized at +20 ℃, capacitors shall meet the limits specified in endurance. (With voltage treatment)										
Resistance to soldering heat	After reflow soldering and then being stabilized at +20 ℃, capacitors shall meet the following limits.										
	Capacitance change	Within ±10 % of the initial value									
	Dissipation factor（tan δ）	Within the initial limit									
	Leakage current	Within the initial limit									

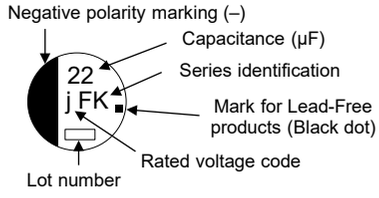
Frequency correction factor for ripple current

Frequency (Hz)	50, 60	120	1 k	10 k	100 k to
Correction factor	0.70	0.75	0.90	0.95	1.00

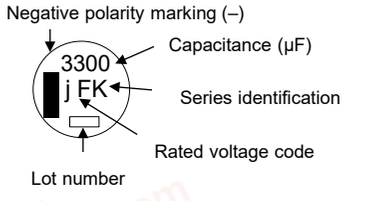
Marking

Example : 6.3 V 22 μF, 6.3 V 3300 μF
Marking color : BLACK

≦ ø10



≧ ø12.5



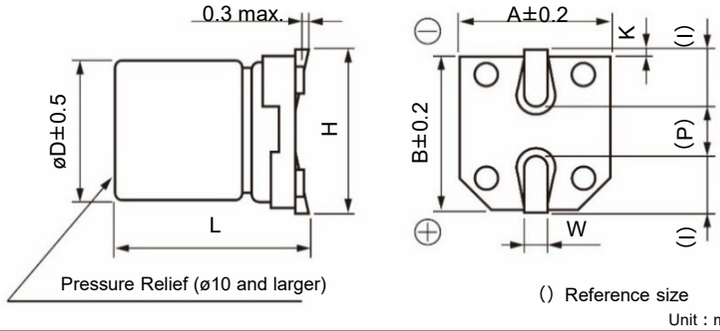
R. voltage code

j	6.3
A	10
C	16
E	25
V	35

Unit : V

H	50
J	63
K	80
2A	100

Dimensions



Unit : mm

Size code	øD	L	A, B	H	I	W	P	K
B	4.0	5.8±0.3	4.3	5.5 max.	1.8	0.65±0.1	1.0	0.35 $^{+0.15}_{-0.20}$
C	5.0	5.8±0.3	5.3	6.5 max.	2.2	0.65±0.1	1.5	0.35 $^{+0.15}_{-0.20}$
D	6.3	5.8±0.3	6.6	7.8 max.	2.6	0.65±0.1	1.8	0.35 $^{+0.15}_{-0.20}$
D8	6.3	7.7±0.3	6.6	7.8 max.	2.6	0.65±0.1	1.8	0.35 $^{+0.15}_{-0.20}$
E	8.0	6.2±0.3	8.3	9.5 max.	3.4	0.65±0.1	2.2	0.35 $^{+0.15}_{-0.20}$
F	8.0	10.2±0.3	8.3	10.0 max.	3.4	0.90±0.2	3.1	0.70±0.2
G	10.0	10.2±0.3	10.3	12.0 max.	3.5	0.90±0.2	4.6	0.70±0.2
H13	12.5	13.5±0.5	13.5	15.0 max.	4.7	0.90±0.3	4.4	0.70±0.3
J16	16.0	16.5±0.5	17.0	19.0 max.	5.5	1.20±0.3	6.7	0.70±0.3
K16	18.0	16.5±0.5	19.0	21.0 max.	6.7	1.20±0.3	6.7	0.70±0.3

・The dimensions of the vibration-proof products, please refer to the page of the mounting specification.

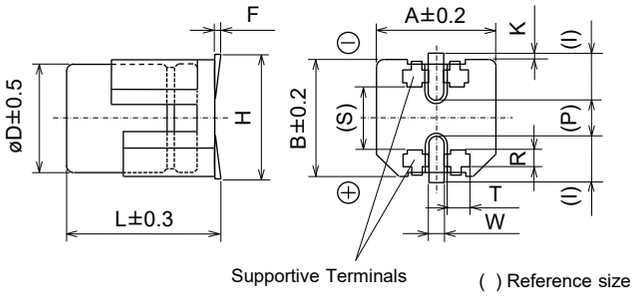
Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use.
Should a safety concern arise regarding this product, please be sure to contact us immediately.

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Dimensions (Vibration-proof products)

✻ The size and shape are different from standard products. Please inquire details of our company.

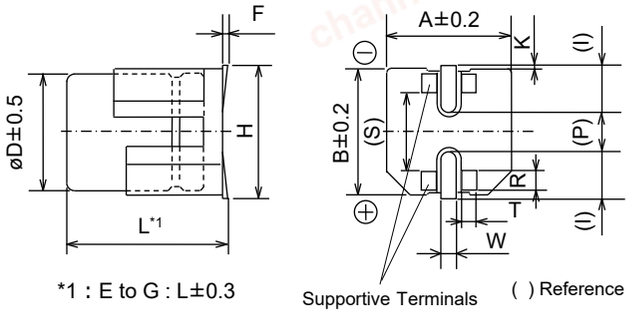
< Size code : D, D8 >



Supportive Terminals ( ) Reference size

※The diagram is not drawn to scale.

< Size code : E, F, G, H13, J16, K16, K21 >



*1 : E to G : L±0.3

Supportive Terminals ( ) Reference size

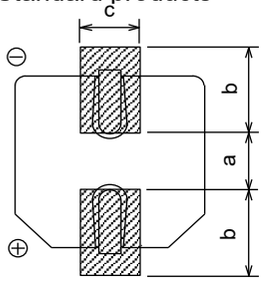
Unit : mm

Size code	øD	L	A, B	H max.	F	I	W	P	K	R	S	T
D	6.3	6.1	6.6	7.8	0 to +0.15	2.4	0.65±0.1	2.2	0.35 $^{+0.15}_{-0.20}$	1.1±0.2	3.3	1.05±0.2
D8	6.3	8.0	6.6	7.8	0 to +0.15	2.4	0.65±0.1	2.2	0.35 $^{+0.15}_{-0.20}$	1.1±0.2	3.3	1.05±0.2
E	8.0	6.5	8.3	9.5	0 to +0.15	3.4	0.7±0.1	2.2	0.35 $^{+0.15}_{-0.20}$	0.70±0.2	5.3	1.7±0.2
F	8.0	10.5	8.3	10.0	0 to +0.15	3.4	1.2±0.2	3.1	0.70±0.2	0.70±0.2	5.3	1.3±0.2
G	10.0	10.5	10.3	12.0	0 to +0.15	3.5	1.2±0.2	4.6	0.70±0.2	0.70±0.2	6.9	1.3±0.2
H13	12.5	13.8	13.5	15.0	–0.1 to +0.15	4.7	1.2±0.2	4.4	0.70±0.3	2.2±0.2	7.1	2.4±0.2
J16	16.0	16.8	17.0	19.0	–0.1 to +0.15	5.5	1.4±0.2	6.7	0.70±0.3	3.0±0.2	9.0	1.9±0.2
K16	18.0	16.8	19.0	21.0	–0.1 to +0.15	6.7	1.4±0.2	6.7	0.70±0.3	3.0±0.2	11.0	1.9±0.2
K21	18.0	21.8	19.0	21.0	–0.1 to +0.15	6.7	1.4±0.2	6.7	0.70±0.3	3.0±0.2	11.0	1.9±0.2

Land / Pad pattern

The circuit board land/pad pattern size for chip capacitors is specified in the following table.
The land pitch influences installation strength and consider it.

● Standard products



Land space



(Table of board land size vs. capacitor size)

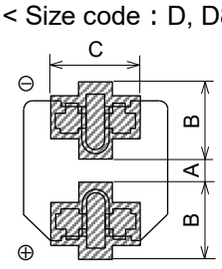
Unit : mm

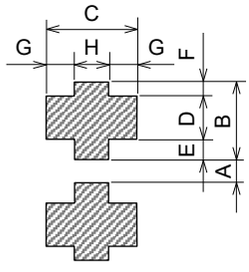
Size code	a	b	c
B (ø4)	1.0	2.5	1.6
C (ø5)	1.5	2.8	1.6
D (ø6.3)	1.8	3.2	1.6
D8 (ø6.3x7.7L)	1.8	3.2	1.6
E (ø8x6.2L)	2.2	4.0	1.6
F (ø8x10.2L)	3.1	4.0	2.0
G (ø10x10.2L)	4.6	4.1	2.0
H (ø12.5)	4.0	5.7	2.0
J (ø16)	6.0	6.5	2.5
K (ø18)	6.0	7.5	2.5

When size “a” is wide, back fi llet can be made, decreasing fi tting strength.

● Vibration-proof products

< Size code : D, D8 >





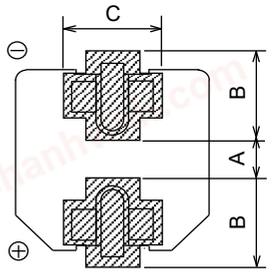
(Table of board land size vs. capacitor size)

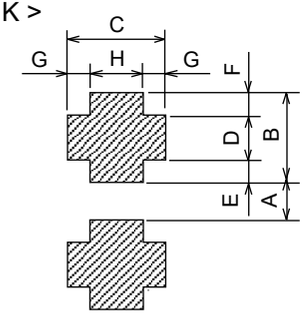
Unit : mm

Size code	A	B	C	D	E	F	G	H
D (ø6.3xL6.1)	1.2	3.6	3.2	2.0	0.95	0.65	1.0	1.2
D8 (ø6.3xL8.0)	1.2	3.6	3.2	2.0	0.95	0.65	1.0	1.2
E (ø8x6.5L)	1.8	4.2	5.0	1.3	1.5	1.4	1.5	2.0
F (ø8x10.5L)	2.7	4.0	4.7	1.3	1.0	1.7	1.1	2.5
G (ø10)	3.9	4.4	4.7	1.3	1.2	1.9	1.1	2.5
H (ø12.5)	3.9	6.0	6.9	2.8	1.3	1.9	2.2	2.5
J (ø16)	5.8	6.8	6.2	3.6	1.3	1.9	1.7	2.8
K (ø18)	5.8	7.3	6.2	3.6	1.8	1.9	1.7	2.8

When size “A” is wide, back fi llet can be made, decreasing fi tting strength.

< Size code : E, F, G, H, J, K >





∗ Take mounting conditions, solderability and fi tting strength into consideration when selecting parts for your company’s design.

∗ The vibration-proof capacitors of size ø6.3 has support terminals extending from the bottom side to the lead edge. Then, make sure to find appropriate soldering conditions to form fillet on the support terminals if required for appearance inspection.

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Explanation of part numbers

◇ Part number system

e.g.: EEEFK0J470UR

EEE	FK	0J	470	U	R
Product classification					

Series	Code
FK	FK

Rated voltage (V)	Code
6.3	0J
10	1A
16	1C
25	1E
35	1V
50	1H
63	1J
100	2A

Capacitance (μF)	Code	Capacitance (μF)	Code
3.3	3R3	390	391
4.7	4R7	470	471
10	100	560	471
22	220	680	681
33	330	1000	102
47	470	1500	152
68	680	2200	152
100	101	3300	152
150	151	4700	152
220	221	6800	152
330	331		

Special code	Code
Miniaturized product	U
D8 size	X
5000 h	G
Others	–

Tape width (mm)	Code
12	R
16, 24	P
32	Q
44	M

Replace for the following configuration

Configuration	Code
Vibration proof	V

Characteristics list

Endurance : 105 ℃ 2000 h (≧ ø12.5 : 5000 h)

Rated voltage (V)	Capacitance (±20 %) (μF)	Case size (mm) øD	Case size (mm) L Standard	Case size (mm) L Vibration-proof	Size code*1	Specification Ripple current*2 (mA rms)	Specification Impedance*3 (Ω)	Specification tan δ*4	Part No. Standard Product	Part No. Vibration-proof product	Reflow	Min. Packaging Q'ty (pcs) Taping
6.3	22	4.0	5.8	–	B	90	1.35	0.26	EEEFK0J220R	–	(1)	2000
	47	4.0	5.8	–	(B)	90	1.35	0.26	EEEFK0J470UR	–	(1)	2000
		5.0	5.8	–	C	160	0.70	0.26	EEEFK0J470R	–	(1)	1000
	100	5.0	5.8	–	(C)	160	0.70	0.26	EEEFK0J101UR	–	(1)	1000
		6.3	5.8	6.1	D	240	0.36	0.26	EEEFK0J101P	EEEFK0J101V	(1)	1000
	220	6.3	5.8	6.1	D	240	0.36	0.26	EEEFK0J221P	EEEFK0J221V	(1)	1000
	330	6.3	7.7	8.0	D8	280	0.34	0.26	EEEFK0J331XP	EEEFK0J331XV	(1)	900
		8.0	6.2	6.5	E	300	0.26	0.26	EEEFK0J331P	EEEFK0J331V	(2)	1000
	470	8.0	10.2	10.5	F	600	0.16	0.26	EEEFK0J471P	EEEFK0J471V	(2)	500
	1000	8.0	10.2	10.5	F	600	0.16	0.26	EEEFK0J102P	EEEFK0J102V	(2)	500
	1500	10.0	10.2	10.5	G	850	0.08	0.26	EEEFK0J152P	EEEFK0J152V	(2)	500
	3300	12.5	13.5	13.8	H13	1100	0.06	0.30	EEVFK0J332Q	EEVFK0J332V	(3)	200
	6800	16.0	16.5	16.8	J16	1800	0.035	0.36	EEVFK0J682M	EEVFK0J682V	(3)	125
10	22	4.0	5.8	–	B	90	1.35	0.19	EEEFK1A220R	–	(1)	2000
	33	4.0	5.8	–	(B)	90	1.35	0.19	EEEFK1A330UR	–	(1)	2000
		5.0	5.8	–	C	160	0.70	0.19	EEEFK1A330R	–	(1)	1000
	150	6.3	5.8	6.1	D	240	0.36	0.19	EEEFK1A151P	EEEFK1A151V	(1)	1000
	220	6.3	7.7	8.0	D8	280	0.34	0.19	EEEFK1A221XP	EEEFK1A221XV	(1)	900
		8.0	6.2	6.5	E	300	0.26	0.19	EEEFK1A221P	EEEFK1A221V	(2)	1000
	330	8.0	10.2	10.5	F	600	0.16	0.19	EEEFK1A331P	EEEFK1A331V	(2)	500
	470	8.0	10.2	10.5	F	600	0.16	0.19	EEEFK1A471P	EEEFK1A471V	(2)	500
	680	8.0	10.2	10.5	F	600	0.16	0.19	EEEFK1A681P	EEEFK1A681V	(2)	500
	1000	10.0	10.2	10.5	G	850	0.08	0.19	EEEFK1A102P	EEEFK1A102V	(2)	500
	2200	12.5	13.5	13.8	H13	1100	0.06	0.21	EEVFK1A222Q	EEVFK1A222V	(3)	200
	4700	16.0	16.5	16.8	J16	1800	0.035	0.25	EEVFK1A472M	EEVFK1A472V	(3)	125
	6800	18.0	16.5	16.8	K16	2060	0.033	0.29	EEVFK1A682M	EEVFK1A682V	(3)	125
16	10	4.0	5.8	–	B	90	1.35	0.16	EEEFK1C100R	–	(1)	2000
	22	4.0	5.8	–	(B)	90	1.35	0.16	EEEFK1C220UR	–	(1)	2000
		5.0	5.8	–	C	160	0.70	0.16	EEEFK1C220R	–	(1)	1000
	47	5.0	5.8	–	(C)	160	0.70	0.16	EEEFK1C470UR	–	(1)	1000
		6.3	5.8	6.1	D	240	0.36	0.16	EEEFK1C470P	EEEFK1C470V	(1)	1000
	68	6.3	5.8	6.1	D	240	0.36	0.16	EEEFK1C680P	EEEFK1C680V	(1)	1000
	100	6.3	5.8	6.1	D	240	0.36	0.16	EEEFK1C101P	EEEFK1C101V	(1)	1000
	150	6.3	7.7	8.0	D8	280	0.34	0.16	EEEFK1C151XP	EEEFK1C151XV	(1)	900
	220	6.3	7.7	8.0	D8	280	0.34	0.16	EEEFK1C221XP	EEEFK1C221XV	(1)	900
		8.0	6.2	6.5	E	300	0.26	0.16	EEEFK1C221P	EEEFK1C221V	(2)	1000
	330	8.0	10.2	10.5	F	600	0.16	0.16	EEEFK1C331P	EEEFK1C331V	(2)	500
	470	8.0	10.2	10.5	F	600	0.16	0.16	EEEFK1C471P	EEEFK1C471V	(2)	500
	680	10.0	10.2	10.5	G	850	0.08	0.16	EEEFK1C681P	EEEFK1C681V	(2)	500
	1500	12.5	13.5	13.8	H13	1100	0.06	0.16	EEVFK1C152Q	EEVFK1C152V	(3)	200
	3300	16.0	16.5	16.8	J16	1800	0.035	0.20	EEVFK1C332M	EEVFK1C332V	(3)	125
	4700	18.0	16.5	16.8	K16	2060	0.033	0.22	EEVFK1C472M	EEVFK1C472V	(3)	125

*1: Size code( ): Miniaturization product
*2: Ripple current (100 kHz / +105 ℃)
*3: Impedance (100 kHz / +20 ℃)
*4: tan δ (120 Hz / +20 ℃)

・Please refer to the page of "Reflow Profile" and "The Taping Dimensions".

Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use.
Should a safety concern arise regarding this product, please be sure to contact us immediately.

Characteristics list

Endurance : 105 ℃ 2000 h (≧ ø12.5 : 5000 h)

Rated voltage (V)	Capacitance (±20 %) (μF)	Case size (mm)			Size code*1	Specification			Part No.		Reflow	Min. Packaging Q'ty (pcs)
		øD	L			Ripple current*2 (mA rms)	Impe-dance*3 (Ω)	tan δ*4	Standard Product	Vibration-proof product		Taping
			Standard	Vibration-proof								
25	10	4.0	5.8	—	B	90	1.35	0.14	EEEFK1E100R	—	(1)	2000
	22	5.0	5.8	—	C	160	0.70	0.14	EEEFK1E220R	—	(1)	1000
	33	5.0	5.8	—	(C)	160	0.70	0.14	EEEFK1E330UR	—	(1)	1000
		6.3	5.8	6.1	D	240	0.36	0.14	EEEFK1E330P	EEEFK1E330V	(1)	1000
	47	6.3	5.8	6.1	D	240	0.36	0.14	EEEFK1E470P	EEEFK1E470V	(1)	1000
	68	6.3	5.8	6.1	D	240	0.36	0.14	EEEFK1E680P	EEEFK1E680V	(1)	1000
	100	6.3	7.7	8.0	D8	280	0.34	0.14	EEEFK1E101XP	EEEFK1E101XV	(1)	900
		8.0	6.2	6.5	E	300	0.26	0.14	EEEFK1E101P	EEEFK1E101V	(2)	1000
	150	8.0	10.2	10.5	F	600	0.16	0.14	EEEFK1E151P	EEEFK1E151V	(2)	500
	220	8.0	10.2	10.5	F	600	0.16	0.14	EEEFK1E221P	EEEFK1E221V	(2)	500
	330	8.0	10.2	10.5	F	600	0.16	0.14	EEEFK1E331P	EEEFK1E331V	(2)	500
	470	10.0	10.2	10.5	G	850	0.08	0.14	EEEFK1E471P	EEEFK1E471V	(2)	500
	1000	12.5	13.5	13.8	H13	1100	0.06	0.14	EEVFK1E102Q	EEVFK1E102V	(3)	200
	1500	16.0	16.5	16.8	J16	1800	0.035	0.14	EEVFK1E152M	EEVFK1E152V	(3)	125
	2200	16.0	16.5	16.8	J16	1800	0.035	0.16	EEVFK1E222M	EEVFK1E222V	(3)	125
	3300	18.0	16.5	16.8	K16	2060	0.033	0.18	EEVFK1E332M	EEVFK1E332V	(3)	125
35	4.7	4.0	5.8	—	B	90	1.35	0.12	EEEFK1V4R7R	—	(1)	2000
	10	4.0	5.8	—	(B)	90	1.35	0.12	EEEFK1V100UR	—	(1)	2000
		5.0	5.8	—	C	160	0.70	0.12	EEEFK1V100R	—	(1)	1000
	22	5.0	5.8	—	C	160	0.70	0.12	EEEFK1V220R	—	(1)	1000
	33	6.3	5.8	6.1	D	240	0.36	0.12	EEEFK1V330P	EEEFK1V330V	(1)	1000
	47	6.3	5.8	6.1	D	240	0.36	0.12	EEEFK1V470P	EEEFK1V470V	(1)	1000
	68	6.3	7.7	8	D8	280	0.34	0.12	EEEFK1V680XP	EEEFK1V680XV	(1)	900
	100	6.3	7.7	8	D8	280	0.34	0.12	EEEFK1V101XP	EEEFK1V101XV	(1)	900
		8.0	10.2	10.5	F	600	0.16	0.12	EEEFK1V101P	EEEFK1V101V	(2)	500
	150	8.0	10.2	10.5	F	600	0.16	0.12	EEEFK1V151P	EEEFK1V151V	(2)	500
	220	8.0	10.2	10.5	F	600	0.16	0.12	EEEFK1V221P	EEEFK1V221V	(2)	500
	330	10.0	10.2	10.5	G	850	0.08	0.12	EEEFK1V331P	EEEFK1V331V	(2)	500
	470	12.5	13.5	13.8	H13	1100	0.06	0.12	EEVFK1V471Q	EEVFK1V471V	(3)	200
	680	12.5	13.5	13.8	H13	1100	0.06	0.12	EEVFK1V681Q	EEVFK1V681V	(3)	200
	1000	16.0	16.5	16.8	J16	1800	0.035	0.12	EEVFK1V102M	EEVFK1V102V	(3)	125
	1500	16.0	16.5	16.8	J16	1800	0.035	0.12	EEVFK1V152M	EEVFK1V152V	(3)	125
50	4.7	4.0	5.8	—	B	60	2.90	0.10	EEEFK1H4R7R	—	(1)	2000
	10	5.0	5.8	—	(C)	85	1.52	0.10	EEEFK1H100UR	—	(1)	1000
		6.3	5.8	6.1	D	165	0.88	0.10	EEEFK1H100P	EEEFK1H100V	(1)	1000
	22	6.3	5.8	6.1	D	165	0.88	0.10	EEEFK1H220P	EEEFK1H220V	(1)	1000
	33	6.3	7.7	8	D8	195	0.68	0.10	EEEFK1H330XP	EEEFK1H330XV	(1)	900
		8.0	6.2	6.5	E	195	0.68	0.10	EEEFK1H330P	EEEFK1H330V	(2)	1000
	47	6.3	7.7	8	D8	195	0.68	0.10	EEEFK1H470XP	EEEFK1H470XV	(1)	900
		8.0	6.2	6.5	E	195	0.68	0.10	EEEFK1H470P	EEEFK1H470V	(2)	1000
	100	8.0	10.2	10.5	F	350	0.34	0.10	EEEFK1H101P	EEEFK1H101V	(2)	500
	150	10.0	10.2	10.5	G	670	0.18	0.10	EEEFK1H151P	EEEFK1H151V	(2)	500
	220	10.0	10.2	10.5	G	670	0.18	0.10	EEEFK1H221P	EEEFK1H221V	(2)	500
	330	12.5	13.5	13.8	H13	900	0.12	0.10	EEVFK1H331Q	EEVFK1H331V	(3)	200
	390	12.5	13.5	13.8	H13	900	0.12	0.10	EEVFK1H391Q	EEVFK1H391V	(3)	200
	470	16.0	16.5	16.8	J16	1610	0.073	0.10	EEVFK1H471M	EEVFK1H471V	(3)	125
	560	16.0	16.5	16.8	J16	1610	0.073	0.10	EEVFK1H561M	EEVFK1H561V	(3)	125
	680	16.0	16.5	16.8	J16	1610	0.073	0.10	EEVFK1H681M	EEVFK1H681V	(3)	125
	1000	16.0	16.5	16.8	J16	1610	0.073	0.10	EEVFK1H102M	EEVFK1H102V	(3)	125
63	4.7	5.0	5.8	—	C	50	3.00	0.08	EEEFK1J4R7R	—	(1)	1000
	10	6.3	5.8	6.1	D	80	1.50	0.08	EEEFK1J100P	EEEFK1J100V	(1)	1000
	22	6.3	7.7	8	D8	120	1.20	0.08	EEEFK1J220XP	EEEFK1J220XV	(1)	900
		8.0	6.2	6.5	E	120	1.20	0.08	EEEFK1J220P	EEEFK1J220V	(2)	1000
	33	8.0	10.2	10.5	F	250	0.65	0.08	EEEFK1J330P	EEEFK1J330V	(2)	500
	47	8.0	10.2	10.5	F	250	0.65	0.08	EEEFK1J470P	EEEFK1J470V	(2)	500
	68	8.0	10.2	10.5	(F)	250	0.65	0.08	EEEFK1J680UP	EEEFK1J680UV	(2)	500
	100	10.0	10.2	10.5	G	400	0.35	0.08	EEEFK1J101P	EEEFK1J101V	(2)	500
	150	12.5	13.5	13.8	H13	800	0.16	0.08	EEVFK1J151Q	EEVFK1J151V	(3)	200
	220	12.5	13.5	13.8	H13	800	0.16	0.08	EEVFK1J221Q	EEVFK1J221V	(3)	200
	470	16.0	16.5	16.8	J16	1410	0.082	0.08	EEVFK1J471M	EEVFK1J471V	(3)	125
	680	18.0	16.5	16.8	K16	1690	0.08	0.08	EEVFK1J681M	EEVFK1J681V	(3)	125

*1: Size code( ): Miniaturization product
*2: Ripple current (100 kHz / +105 ℃)
*3: Impedance (100 kHz / +20 ℃)
*4: tan δ (120 Hz / +20 ℃)

・Please refer to the page of "Reflow Profile" and "The Taping Dimensions".

Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use.
Should a safety concern arise regarding this product, please be sure to contact us immediately.

FK series

Characteristics list

Endurance : 105 ℃ 2000 h (≧ ø12.5 : 5000 h)

Rated voltage (V)	Capacitance (±20 %) (μF)	Case size (mm)			Size code	Specification			Part No.		Reflow	Min. Packaging Q'ty (pcs)
		øD	L			Ripple current*1 (mA rms)	Impe-dance*2 (Ω)	tan δ*3	Standard Product	Vibration-proof product		Taping
			Standard	Vibration-proof								
80	3.3	5.0	5.8	–	C	25	5.00	0.08	EEEFK1K3R3R	–	(1)	1000
	4.7	6.3	5.8	6.1	D	40	3.00	0.08	EEEFK1K4R7P	EEEFK1K4R7V	(1)	1000
	10	6.3	7.7	8	D8	60	2.40	0.08	EEEFK1K100XP	EEEFK1K100XV	(1)	900
		8.0	6.2	6.5	E	60	2.40	0.08	EEEFK1K100P	EEEFK1K100V	(2)	1000
	22	8.0	10.2	10.5	F	130	1.30	0.08	EEEFK1K220P	EEEFK1K220V	(2)	500
	33	8.0	10.2	10.5	F	130	1.30	0.08	EEEFK1K330P	EEEFK1K330V	(2)	500
	47	10.0	10.2	10.5	G	200	0.70	0.08	EEEFK1K470P	EEEFK1K470V	(2)	500
	68	12.5	13.5	13.8	H13	500	0.32	0.08	EEVFK1K680Q	EEVFK1K680V	(3)	200
	100	12.5	13.5	13.8	H13	500	0.32	0.08	EEVFK1K101Q	EEVFK1K101V	(3)	200
	150	12.5	13.5	13.8	H13	500	0.32	0.08	EEVFK1K151Q	EEVFK1K151V	(3)	200
	330	16.0	16.5	16.8	J16	793	0.17	0.08	EEVFK1K331M	EEVFK1K331V	(3)	125
	470	18.0	16.5	16.8	K16	917	0.153	0.08	EEVFK1K471M	EEVFK1K471V	(3)	125
100	22	8.0	10.2	10.5	F	130	1.30	0.07	EEEFK2A220P	EEEFK2A220V	(2)	500
	33	10.0	10.2	10.5	G	200	0.70	0.07	EEEFK2A330P	EEEFK2A330V	(2)	500
	47	12.5	13.5	13.8	H13	500	0.32	0.07	EEVFK2A470Q	EEVFK2A470V	(3)	200
	68	12.5	13.5	13.8	H13	500	0.32	0.07	EEVFK2A680Q	EEVFK2A680V	(3)	200
	100	16.0	16.5	16.8	J16	793	0.17	0.07	EEVFK2A101M	EEVFK2A101V	(3)	125
	150	16.0	16.5	16.8	J16	793	0.17	0.07	EEVFK2A151M	EEVFK2A151V	(3)	125
	220	18.0	16.5	16.8	K16	917	0.153	0.07	EEVFK2A221M	EEVFK2A221V	(3)	125
	330	18.0	16.5	16.8	K16	917	0.153	0.07	EEVFK2A331M	EEVFK2A331V	(3)	125

Endurance： 105 ℃ 5000 h

Rated voltage (V)	Capacitance (±20 %) (μF)	Case size (mm)			Size code	Specification			Part No.		Reflow	Min. Packaging Q'ty (pcs)
		øD	L			Ripple current*1 (mA rms)	Impe-dance*2 (Ω)	tan δ*3	Standard Product	Vibration-proof product		Taping
			Standard	Vibration-proof								
6.3	470	8.0	10.2	10.5	F	600	0.16	0.26	EEEFK0J471GP	EEEFK0J471GV	(2)	500
	1000	8.0	10.2	10.5	F	600	0.16	0.26	EEEFK0J102GP	EEEFK0J102GV	(2)	500
	1500	10.0	10.2	10.5	G	850	0.08	0.26	EEEFK0J152GP	EEEFK0J152GV	(2)	500
10	330	8.0	10.2	10.5	F	600	0.16	0.19	EEEFK1A331GP	EEEFK1A331GV	(2)	500
	470	8.0	10.2	10.5	F	600	0.16	0.19	EEEFK1A471GP	EEEFK1A471GV	(2)	500
	680	8.0	10.2	10.5	F	600	0.16	0.19	EEEFK1A681GP	EEEFK1A681GV	(2)	500
	1000	10.0	10.2	10.5	G	850	0.08	0.19	EEEFK1A102GP	EEEFK1A102GV	(2)	500
16	330	8.0	10.2	10.5	F	600	0.16	0.16	EEEFK1C331GP	EEEFK1C331GV	(2)	500
	470	8.0	10.2	10.5	F	600	0.16	0.16	EEEFK1C471GP	EEEFK1C471GV	(2)	500
	680	10.0	10.2	10.5	G	850	0.08	0.16	EEEFK1C681GP	EEEFK1C681GV	(2)	500
25	150	8.0	10.2	10.5	F	600	0.16	0.14	EEEFK1E151GP	EEEFK1E151GV	(2)	500
	220	8.0	10.2	10.5	F	600	0.16	0.14	EEEFK1E221GP	EEEFK1E221GV	(2)	500
	330	8.0	10.2	10.5	F	600	0.16	0.14	EEEFK1E331GP	EEEFK1E331GV	(2)	500
	470	10.0	10.2	10.5	G	850	0.08	0.14	EEEFK1E471GP	EEEFK1E471GV	(2)	500
35	100	8.0	10.2	10.5	F	600	0.16	0.12	EEEFK1V101GP	EEEFK1V101GV	(2)	500
	150	8.0	10.2	10.5	F	600	0.16	0.12	EEEFK1V151GP	EEEFK1V151GV	(2)	500
	220	8.0	10.2	10.5	F	600	0.16	0.12	EEEFK1V221GP	EEEFK1V221GV	(2)	500
	330	10.0	10.2	10.5	G	850	0.08	0.12	EEEFK1V331GP	EEEFK1V331GV	(2)	500
50	100	8.0	10.2	10.5	F	350	0.34	0.10	EEEFK1H101GP	EEEFK1H101GV	(2)	500
	150	10.0	10.2	10.5	G	670	0.18	0.10	EEEFK1H151GP	EEEFK1H151GV	(2)	500
	220	10.0	10.2	10.5	G	670	0.18	0.10	EEEFK1H221GP	EEEFK1H221GV	(2)	500

*1: Size code( ): Miniaturization product　　*2: Ripple current (100 kHz / +105 ℃)

*3: Impedance (100 kHz / +20 ℃)　　*4: tan δ (120 Hz / +20 ℃)

・Please refer to the page of "Reflow Profile" and "The Taping Dimensions".

Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use.
Should a safety concern arise regarding this product, please be sure to contact us immediately.

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Safety and Legal Matters to Be Observed

Product specifications and applications

- Please be advised that this product and product specifications are subject to change without notice for improvement purposes. Therefore, please request and confirm the latest delivery specifications that explain the specifications in detail before the final design, or purchase or use of the product, regardless of the application. In addition, do not use this product in any way that deviates from the contents of the company's delivery specifications.
- Unless otherwise specified in this catalog or the product specifications, this product is intended for use in general electronic equipment (AV products, home appliances, commercial equipment, office equipment, information and communication equipment, etc.).
  When this product is used for the following special cases, the specification document suited to each application shall be signed/sealed (with Panasonic Industry and the user) in advance..These include applications requiring special quality and reliability, wherein their failures or malfunctions may directly threaten human life or cause harm to the human body (e.g.: space/aircraft equipment, transportation/traffic equipment, combustion equipment, medical equipment, disaster prevention/crime prevention equipment, safety equipment, etc.).

Safety design and product evaluation

- Please ensure safety through protection circuits, redundant circuits, etc., in the customer's system design so that a defect in our company's product will not endanger human life or cause other serious damage.
- This catalog shows the quality and performance of individual parts. The durability of parts varies depending on the usage environment and conditions. Therefore, please ensure to evaluate and confirm the state of each part after it has been mounted in your product in the actual operating environment before use.
  If you have any doubts about the safety of this product, then please notify us immediately, and be sure to conduct a technical review including the above protection circuits and redundant circuits at your company.

Laws / Regulations / Intellectual property

- The transportation of dangerous goods as designated by UN numbers, UN classifications, etc., does not apply to this product. In addition, when exporting products, product specifications, and technical information described in this catalog, please comply with the laws and regulations of the countries to which the products are exported, especially those concerning security export control.
- Each model of this product complies with the RoHS Directive (Restriction of the use of hazardous substances in electrical and electronic equipment) (2011/65/EU and (EU) 2015/863). The date of compliance with the RoHS Directive and REACH Regulation varies depending on the product model.
  Further, if you are using product models in stock and are not sure whether or not they comply with the RoHS Directive or REACH Regulation, please contact us by selecting "Sales Inquiry" from the inquiry form.
- During the manufacturing process of this product and any of its components and materials to be used, Panasonic Industry does not intentionally use ozone-depleting substances stipulated in the Montreal Protocol and specific bromine-based flame retardants such as PBBs (Poly-Brominated Biphenyls) / PBDEs (Poly-Brominated Diphenyl Ethers). In addition, the materials used in this product are all listed as existing chemical substances based on the Act on the Regulation of Manufacture and Evaluation of Chemical Substances.
- With regard to the disposal of this product, please confirm the disposal method in each country and region where it is incorporated into your company's product and used.
- The technical information contained in this catalog is intended to show only typical operation and application circuit examples of this product. This catalog does not guarantee that such information does not infringe upon the intellectual property rights of Panasonic Industry or any third party, nor imply that the license of such rights has been granted.
- Design, materials, or process related to technical owned by Panasonic Industry are subject to change without notice.

Panasonic Industry will assume no liability whatsoever if the use of our company's products deviates from the contents of this catalog or does not comply with the precautions. Please be advised of these restrictions.

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Matters to Be Observed When Using This Product

(Conductive polymer hybrid aluminum electrolytic capacitor / Aluminum electrolytic capacitor)

Use environments and cleaning conditions

■ This product (capacitor) is intended for standard general-purpose use in electronic equipment, and is not designed for use in the specific environments described below. Using the product in such specific environments or service conditions, therefore, may affect the performance of the product.
Check with us about the performance and reliability of the product first before using the product.

(1) Used at a temperature higher than the upper limit category temperature or lower than the lower limit category temperature.
(2) Used in an environment where the product is directly exposed to water, salt water, oil, etc., or in a liquid, such as water, oil, chemicals, and organic solvents.
(3) Used in an outdoor environment where the product is exposed to direct sunlight, ozone, radiation, UV-rays, etc., or in a dusty place.
(4) Used in a wet place (dew concentration on a resistor, water leakage, etc.), a place exposed to sea breeze, or a place filled with a corrosive gas, such as Cl_2, H_2S, NH_3, SO_2, or NO_X.
(5) Used in an environment filled with a toxic gas (hydrogen sulfide, sulfurous acid, nitrous acid, chlorine and chlorine compound, bromine and bromine compound, ammonia, etc.)
(6) Used in an environment where static electricity and electromagnetic waves are strong.
(7) Located close to heating component or a flammable material, such as a vinyl cable.
(8) Sealed with a resin, etc.
(9) Cleansed with a solvent, water, or a water-soluble cleaner, to remove solder flux after soldering.
(10) Used in an environment where an acidic or alkali atmosphere is present.
(11) Used in an environment where excessive vibration or mechanical shocks exceeding a specified range is applied to the product (even if the applied vibration or mechanical shocks is within the specified range, it may cause the product to resonate, in which a large vibration acceleration may be generated. Make sure to evaluate/check such vibrations or impacts applied to the product in an actual service condition).
(12) Used under a low atmospheric pressure condition or depressurized condition.

■ The capacitor withstands an immersion cleaning process where the board carrying the product is immersed in a cleaning solution of 60 °C or lower for less than 5 minutes and withstands an ultrasonic cleaning process as well. However, ensure to thoroughly rinse and dry it. Some cleaning methods erase or blur notes on the capacitor in some cases.
Some types of capacitors are not washable and some cleaning solutions cannot be used to clean a capacitor.
If you are not sure about which type of capacitor is not washable or which cleaning solution cannot be used, please contact us. Solvents you can use to clean the board are as follows.

Pine Alpha ST-100S, Aqua Cleaner 210SEP, Cleanthrough 750H/750L/710M, Sun Elec B-12, Techno Cleaner 219, Cold Cleaner P3-375, DK Be clear CW-5790, Terpene Cleaner EC-7R, Techno Care FRW-17/FRW-1/FRV-1

■ Keep the cleaning solution under strict contamination control (conductivity, pH, specific gravity, water content, etc.).
A contaminated cleaning solution will show a high chlorine concentration, thereby corroding the interior of the capacitor in some cases. Keep the flux concentration in the cleaning solution at a 2% mass or less.

■ Unless otherwise specified in the specifications, avoid cleaning the capacitor with a halogen-based solvent, an alkaline solvent, a petroleum-based solvent, xylene, or acetone. Using a halogen-based solvent may result in a case where the solvent infiltrates (leaks) into the capacitor and break-down releasing chlorine, which reacts with aluminum which can corrode the capacitor interior. 1-1-1 trichloroethane is particularly harmful to a capacitor. Never use it to clean a capacitor.
A alkaline solvent may corrode (dissolve) an aluminum case, a petroleum-based solvent and xylene may damage the sealing rubber and accelerate its deterioration, and acetone may erase notes on the capacitor.
To protect the global environment, refrain from using an ozone depleting substance as the cleaning solution.

■ Right after the board cleaning, subject the capacitor to a forced drying process so that no cleaning solution remains between the sealing part of the capacitor and the printed board.
Set a drying temperature equal to or lower than the upper limit category temperature.

■ When an adhesive or coating agent is used to fix the capacitor and prevent dampening of the board, specific types of solvents included in some adhesives or coating agents may corrode the capacitor. Select a non-halogen solvent for the material making up the adhesive or coating agent. Do not use a chloroprene-based polymer.
Solidify and dry the adhesive or coating agent sufficiently to prevent its solvent component from remaining on the capacitor.
Leave at least 1/3 of the sealing part unsealed on the surface to which the adhesive or coating agent is applied.

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■ Do not use the product in a structure sealed by potting or molding. The pressure of a molding resin on a capacitor may deform the capacitor. In addition, the resin covering the capacitor may affect its heat dissipation performance or may leak into the product. These factors lead to the significant degradation of the capacitor's characteristics and reliability. There is also a concern that an electrolytic solution permeating the sealing rubber may agglomerate and cause a short circuit.

■ When the capacitor is used in a circuit where an impact voltage is applied or a high voltage is applied in a short period (transient phenomenon) or a high pulse voltage is applied, make sure to use the capacitor at a voltage equal to or lower than its rated voltage.

■ The product contains an electrolytic. Improper use of the capacitor leads not only to the rapid degradation of its characteristics but also to electrolytic leakage. These problems damage the circuit board and may lead to destruction of the entire circuit set.

Response to anomalies and handling conditions

■ When you see gas coming out of an activated pressure relief valve of a capacitor during use of a circuit set, turn off the main power supply of the circuit set or pull the power cord plug out of the wall-outlet. If you leave the power supply on and the capacitor short-circuits, it will damage the circuit, or the gas can turn into a liquid, which will cause the circuit to short. In the worst case scenarios, these events may develop into a more serious incident, such as burnout of the circuit set. The gas coming out of the pressure relief valve of a capacitor is not smoke, but is the electrolytic solution in its gaseous state.

■ When the pressure valve of the capacitor is activated, it emits a high-temperature gas of over 100 °C. Do not bring your face near the valve. In case the gas jetting out of the valve gets in your eyes or comes into your mouth, wash your eyes with water or rinse your mouth immediately. If the gas hits your skin, wash it away with soap.

■ If you touch a terminal of the product during use of the circuit set, you will get an electric shock. The aluminum case of the product has an exposed part with no insulation. Do not touch the exposed part because it is as dangerous as the terminal.

■ Do not create a short circuit between terminals of the product by inserting a conductor therebetween. Do not splash a conductive solution, such as an acidic or alkali solution, on the capacitor. It puts the capacitor in a shorted state, which causes the circuit to fail and destroys the capacitor as well.

■ When a silicone material containing a relatively large amount of a low-molecular-weight siloxane is located close to the product, it may cause the capacitor problems with its electrical performance.

■ When electronic equipment having the capacitor built therein is exported to overseas markets, wooden packaging materials are fumigated with a halogen compound, such as methyl bromide. In such cases, if the packaging material subjected to the fumigation treatment is not dried sufficiently, halogen remaining on the packaging material may leach into the capacitor during transportation and trigger a corrosive reaction in the capacitor. When carrying out the fumigation treatment, carefully examine the dried packaging material to confirm that no halogen remains on the packaging material. Never fumigate the entire electronic equipment in its packaged state.

Reliability and product life

■ The product life is affected by temperatures. In general, a 10 °C drop in the temperature will double the life. Use the capacitor at a temperature as low as possible from the upper limit category temperature.

■ Using a capacitor under a temperature condition outside a specified temperature range causes heavy degradation of the capacitor characteristics, which may result in breakage of the capacitor. You need to confirm not only the ambient temperature and internal temperature of the capacitor but also the temperature of the capacitor's top surface, which is given by radiant heat from built-in heating elements (a power transistor, IC, resistance, etc.) and heat generated by self-heating induced by ripple current. Do not place a heating element on the back of the capacitor.

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■ The product life is given by the following equation.

$$L2 = L1 \times 2^{\frac{T1-(T2+\Delta T)}{10}} \quad \text{Where } T1 \geqq T2$$

L1 : Guaranteed life (h) at temperature T_1 (°C)
L2 : Expected life (h) at temperature T_2 (°C)
T1 : Upper category temperature (°C)
T2 : Ambient temperature of capacitor (°C)
⊿T : Temperature increase caused by ripple current (°C)

* In the case of a hybrid type, category temperature (°C) + temperature increase caused by rated ripple current (°C)

■ Do not use the product for a period longer than its specified service life. A capacitor with its service life ended may cause the following problems: rapid degradation of the product characteristics, short circuit, unnecessary activation of the pressure valve, electrolytic solution leakage, etc. Note that the estimated service life is not longer than 15 years due to the limited environment-resistant property of the sealing rubber.

■ When the capacitor is used under a high-temperature condition for a long period, minute cracks develop on the surface of the sealing rubber or the case surface turns brown in some cases. These phenomena, however, have no effects on the reliability of the capacitor.

■ A capacitor conforming to "AEC-Q200" refers to a capacitor having passed some or all of evaluation test items defined in AEC-Q200.
To know the detailed specifications of each capacitor or specific evaluation test scores, please contact us.
We issue a the product specifications sheet for each product ordered. Please confirm the product specifications sheet when you place an order to us.

Circuit design and circuit board design

■ The electrical characteristics change as a result of temperature/frequency fluctuations. Take electrical characteristic changes into consideration when working out a circuit design.

(1) Temperature fluctuations
High-temperature condition : increase in leak current
Low-temperature condition : decrease in capacitance, increase in the tangent to the loss angle, increase in impedance (the hybrid type is excluded), etc.
(2) Frequency fluctuations
High-frequency condition : decrease in capacitance, increase in the tangent to the loss angle, decrease in impedance, etc.
Low-frequency condition : more heat generation by ripple current as a result of an increase in equivalent series resistance

■ The group of factors described below may lead to rapid degradation of the capacitor characteristics, short circuit, or electrolytic solution leakage. They may give rise to sharp heat/gas generation, too, in which case the increasing internal pressure actuates the pressure valve, causes the electrolytic solution to leak out of the sealing part, and, in a worst-case scenario, causes an explosion or ignition incident. When a capacitor bursts, it may scatter flammable materials (electrolytic solution, etc.) in its surroundings.

(1) Reverse voltage: The capacitor has preset polarity. Do not apply a reverse voltage to the capacitor. Confirm the polarity indicated on the capacitor and then use it.
(2) Charge/discharge: Avoid using the capacitor in a circuit that frequently repeats sharp charge/discharge cycles or a circuit that requires relatively slow but highly frequent charge/discharge cycles. In cases where you use the capacitor in such circuits, make sure to inform us of the charge/discharge conditions.
Ensure that a rush current does not exceed 100 A.
(3) ON/OFF: Avoid using the capacitor in an on/off circuit that repeatedly switches on and off more than 10,000 times a day. In cases where you use the product in such circuits, make sure to inform us of the circuit conditions, etc.
(4) Overvoltage: Do not apply an overvoltage higher than the rated voltage (higher than the surge voltage when the voltage application period is short). A peak value given by superposing a ripple voltage (AC component) on a DC voltage must be equal to or lower than the rated voltage.
(5) Ripple current: Do not allow an excessively large ripple current (larger than the rated ripple current specified in the specifications) to flow through the capacitor. Even if a ripple current flow in the capacitor is equal to or smaller than the rated ripple current, a reverse voltage flow may be generated in the capacitor when the DC bias voltage is low flow in the capacitor. Keep the ripple current flow within a range in which no reverse voltage is generated.
Even if the ripple current flow is kept equal to or smaller than the rated ripple current, using the capacitor for a period longer than its service life intensifies the degradation of the ESR characteristics, resulting in an increase in internal heating caused by the ripple current. As a result, the pressure valve is actuated, the exterior case or rubber swells, the electrolytic solution leaks, and, in a worst-case scenario, the capacitor short-circuits and ignites or explodes.

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■ Because the impedance of the capacitor is close to the circuit impedance, capacitors connected in parallel in the circuit may damage the whole current balance, in which, a ripple current higher than the rated ripple current may flow in some of the capacitors. To prevent concentration of ripple current on the low-impedance side, use capacitors with the same part number and avoid the partiality of cable impedances. Do not use capacitors connected in series.

■ When the capacitor is mounted on a double-side wiring board, do not place the wiring pattern directly underneath where the product is mounted. In case the electrolytic solution leaks out, it may short-circuit the pattern and cause tracking or migration. Consider a case where the product is a radial lead capacitor and is mounted on a board with through-holes. In this case, if the sealing part of the capacitor and the board surface stick close to each other, solder flows up to the capacitor during a dip soldering process, which may cause short circuit between the anode and cathode of the capacitor. In such a case, the outer laminate of the product may be damaged. The position of holes, therefore, must be determined properly.

■ When designing a printed board carrying radial lead capacitors, make through-holes across the gap equal to the gap between the leads (terminals) of the capacitor. If the gap between the through-holes is narrower or wider than the gap between the leads, stress is applied to the leads when the capacitor is inserted in the holes.
This may result in increasing leak current, short circuit, wire breaking, or electrolytic solution leakage.

■ A capacitor which has the pressure valve on the case must be provided with a space formed above the pressure valve so that the pressure valve operates without hinderance. When the product is 6.3 mm to 16 mm in diameter, form a space of 2 mm or larger. When the product is 18 mm in diameter, form a space of 3 mm or larger.
If the space is not large enough, it will impair the operability of the pressure valve and may lead to an explosion incident.

■ Design the circuit in such that the pattern, especially a line pattern carrying high voltage or large current, is not formed above the pressure valve. Upon its activation, the pressure valve emits a flammable high-temperature gas of over 100 ℃. This may cause a secondary accident, such as the gas condensing on the pattern and the wire sheathing being melted and catching on fire.

■ Be careful with resonance of the capacitor mounted on the board. When a large load is applied to the capacitor at the frequency close to the resonance frequency, it may cause the capacitor to come off or widely change its characteristics.

■ Completely isolate the case of the capacitor from the cathode terminal and the circuit pattern.

■ The laminate or outer sleeve covering of the product is for displaying information on the product and does not have a guaranteed insulating function.
The laminate may turn brown under a high-temperature condition. However, that does not cause problems with markings recognition on the product surface or electrical performance.
The outer sleeve may crack when dipped in a xylene or toluene solution and exposed to high temperature.

Mounting conditions

■ Do not reuse a capacitor that was incorporated in a circuit set and energized in the past. Do not use a capacitor that was dropped on the floor.
Do not use a capacitor in its compressed form. Compressing the capacitor makes it less airtight, resulting in poor performance, shorter guaranteed life, and electrolyte leakage.

■ A re-striking voltage is generated in a capacitor in some cases. In such a case, let the capacitor discharge through a resistor of about 1 kΩ.

■ When a capacitor is kept in storage for a long period, you may find the leak current from the capacitor has increased. In such a case, make voltage adjustment through a resistor of about 1 kΩ.

■ Before mounting the capacitor on the board, confirm the ratings (capacitance, rated voltage, etc.) and polarity of the capacitor. Before mounting a surface-mounted type capacitor, confirm its terminal dimensions and land size.
Before mounting a radial lead type capacitor, confirm its terminal interval and hole interval. If the terminal interval is not the specified one, stress is applied to internal elements, which may cause problems, such as a short circuit and insufficient mounting strength.
When the terminal interval and the hole interval of the radial lead type capacitor do not match and therefore the capacitor's leads need to be readjusted, make sure that the readjustment does not apply any stress to the capacitor's body.

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- Confirm the applied pressure when using an automatically mounting process for a surface-mounted type capacitor. Excessive pressure may result in increasing leak current, short circuit, the capacitor coming off from the board, and the like. When automatically mounting the radial lead type capacitor, check the wear of a cutter for cutting the leads and confirm that the angle of clinching the leads is not too acute with regards to the board. Clinching the leads at too acute of an angle applies tensile stress to the leads, which may lead to destruction of the capacitor.

- Follow soldering conditions (preheating, soldering temperature/time, the number of soldering, etc.) in the specification sheet. A high peak temperature or a long heating time causes the degradation of electrical characteristics or a reduction in the guaranteed life. Note that the specified soldering conditions indicate conditions under which the degradation of capacitor characteristics do not occur but do not indicate conditions under which stable soldering can be performed. Check and set conditions under which stable soldering can be performed, on a case-by-case basis. Measure the temperature of the capacitor, using a thermocouple bonded to the top of the capacitor with an epoxy-based adhesive. This temperature measurement must be conducted in a mass-production setup.

- The surface-mounted type capacitor is soldered by reflow soldering only. It cannot be soldered by flow soldering or dip soldering. Carry out reflow soldering with an atmospheric heat transfer method using infrared hot air, etc.
  When carrying out two rounds of reflow processes, carry out the second reflow process after the capacitor's temperature settles down to a normal temperature. In the case of VPS reflow, a sharp rise in the capacitor temperature causes a change in the characteristics and appearance of the capacitor, which may give rise to a problem with capacitor mounting. We therefore recommend execution of VPS flow at a temperature rise rate of 3 °C/second or lower. For more information about this matter, please contact us.

- Reflow soldering, under the reflow conditions we recommend, might result in discoloring or swelling of the case or crack formation on the ink mark indicating the cathode. These minor problems, however, do not affect the reliability of the capacitor at all.

- A 6.3-mm diameter vibration-resistant capacitor has a structure that covers the auxiliary terminals to the sides of a seat plate. In cases where you confirm formation of a fillet on the sides of the auxiliary terminals by an image recognition means, etc., examine soldering conditions for the formation of a sufficient fillet on the auxiliary terminals in advance before carrying out the soldering process.
  Even if the formation of a sufficient fillet on the auxiliary terminals is not confirmed, a solder junction between the lower surface of the auxiliary terminals and the board ensures vibration-resistant performance, meaning the reliability of the capacitor is not affected.

- The radial lead type capacitor cannot be soldered by reflow soldering. Do not dip the capacitor body, except the leads, in solder. Heat from the solder raises the internal pressure of the capacitor and destroys it. Solder the capacitor according to the following soldering conditions: soldering temperature of 260 °C ±5 °C and soldering time of 10 seconds ±1 second.

- Ensure that other components do not come in contact with the capacitor during the soldering process. When a radial lead type capacitor is set in close contact with the board, check the soldered state of the capacitor well, because its sealing rubber has no venting structure.

- When manually soldering the capacitor, follow the soldering conditions (soldering temperature/time) specified in the specification sheet or adopt a soldering temperature of 350 °C and a soldering time of 3 seconds or less.
  When you need to remove a capacitor already soldered, remove it after the solder is melted sufficiently so that no stress is applied to the terminals of the capacitor. Be careful not to let the solder iron tip touch the capacitor.
  The solder iron touching the capacitor may damage the capacitor.

- When the temperature of the capacitor becomes extremely high due to preheating, solidification of the setting resin, etc., may cause the outer sleeve of the capacitor to shrink or crack. When treating the capacitor in a thermosetting furnace, etc., place the capacitor in an atmosphere of 150 °C for 2 minutes or less.

- Do not tilt or twist the capacitor soldered to a printed board or hold the capacitor to carry the board or hit the capacitor against something. Such actions apply a force to the internal elements through the terminals and may destroy the product.

- Using highly active halogenous (chlorine-based or bromic) solder flux poses a concern that residual solder flux will have negative impact on the performance and reliability of the capacitor. Check the influence of residual solder flux before using such solder flux.

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Storage conditions

■ A capacitor left for a long period is prone to have a greater flow of leak current. This happens because the oxide film deteriorates under a no-load condition. Voltage application to the capacitor reduces the leak current.
However, at the start of voltage application, a large flow of film recovery current increases the leak current, which may cause a circuit failure, etc.

■ The storage period of a capacitor is 42 months from the shipment inspection day. However, the storage period of capacitors not listed in the following table is specified as 12 months.
Store the capacitor in a place where a normal temperature condition (5°C to 35°C) and a normal humidity condition (45% to 85%) are maintained and direct sunlight is blocked.

Product category	Series	Storage period
Hybrid type	All hybrid series	42 months from the shipment inspection day
Surface-mounted type other than the hybrid type	S (hot lead-free reflow), HA (hot lead-free reflow) HB (hot lead-free reflow, 5.4 mm in height) HC, HD, FCA, FC, FKA, FK, FKS, FP,FT, FH, FN TG, TK, TP, TC, TCU, TQ	
Radial lead type other than the hybrid type	FC-A, FK-A, HD-A, TA-A, TP-A, FP-A	

■ Avoid storing the capacitor in environments not specified in the delivery specification sheet or in the following environments or conditions.

(1) Used at a temperature higher than the upper limit category temperature or lower than the lower limit category temperature
(2) Environments where the capacitor is exposed to water, salt water, or oil
(3) Environments where dew concentrates on the capacitor
(4) Environments filled with a toxic gas (hydrogen sulfide, sulfurous acid, nitrous acid, chlorine and chlorine compound, bromine and bromine compound, ammonia, etc.)
(5) Environments where the product is exposed to ozone, radiation, UV-rays, etc.
(6) Environments where vibrations or mechanical shocks exceeding a specified range is applied to the capacitor

Reference information

Guidelines

Some of the product use guidelines described herein are excerpted from JEITA RCR-2367D "Safety application guide for fixed aluminum electrolytic capacitors for use in electronic equipment," a technical report issued by the Japan Electronics and Information Technology Industries Association on October 2017. For more detailed information, please see the above technical report.

Intellectual property

Panasonic Group provides customers with safe products and services. We are also making great efforts to protect our intellectual property rights for Panasonic Group products. Typical patents related to this product are as follows. (Hybrid type)

[U.S. patent]
USP Nos. 7497879, 7621970, 9208954, 9595396, 9966200, 10453618, 10559432, 10679800, 10685788, and 10790095.

[Japanese patent]
Japanese Patent No. 5360250

[European patent]
EP-A Nos. 1808875 and 2698802